

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	4487	buried near1 contact\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:12
L2	547114	sti or (trench adj isolat\$3) or isolation\$1	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:12
L3	736	1 same 2	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:12
L4	483001	etch\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:12
L5	667	3 and 4	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:13
L6	217452	nitride or (silicon adj nitride) or "si.sub.3 n.sub.4" or si3n4	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:13
L7	488	5 and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:14
L8	124724	polysilicon or polysi or (polycrystalline adj (silicon or si))	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:14
L9	442	7 and 8	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:25

L10	856072	interconnect\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:26
L11	1285664	active	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:26
L12	34392	2 and 4 and 6	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:26
L13	114366	(trench\$2 or recess\$2 or hole\$1 or opening\$1) with 4	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:28
L15	13459	13 same 2	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:29
L17	631	12 and 15 and 8 and 1	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:30
L18	401	17 not 9	US-PGPUB; USPAT; USOCR; EPO; JPO; IBM_TDB	OR	ON	2005/04/26 15:30